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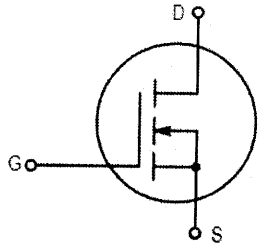
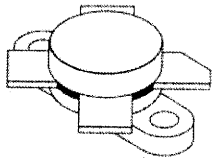
MRF151

150 W, 50 V, 175 MHz
N–CHANNEL
BROADBAND
RF POWER MOSFET





CASE 211–11, STYLE 2

The RF MOSFET Line
RF Power Field-Effect Transistor
N–Channel Enhancement–Mode MOSFET

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain–Source Voltage	V_{DSS}	125	Vdc
Drain–Gate Voltage	V_{DGO}	125	Vdc
Gate–Source Voltage	V_{GS}	±40	Vdc
Drain Current — Continuous	I_D	16	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	300 1.71	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C
Operating Junction Temperature	T_J	200	°C

THERMAL CHARACTERISTICS

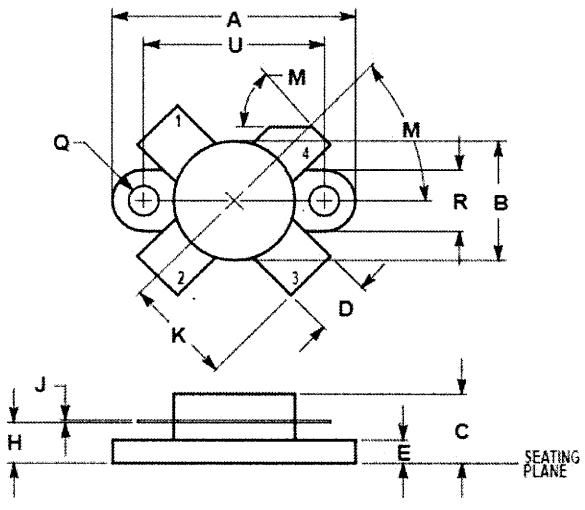
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.6	°C/W

NOTE — **CAUTION** — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

Quality Semi-Conductors

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain–Source Breakdown Voltage (V_{GS} = 0, I_D = 100 mA)	$V_{(BR)DSS}$	125	—	—	Vdc
Zero Gate Voltage Drain Current (V_{DS} = 50 V, V_{GS} = 0)	I_{DSS}	—	—	5.0	mAdc
Gate–Body Leakage Current (V_{GS} = 20 V, V_{DS} = 0)	I_{GSS}	—	—	1.0	μAdc
ON CHARACTERISTICS					
Gate Threshold Voltage (V_{DS} = 10 V, I_D = 100 mA)	$V_{GS(th)}$	1.0	3.0	5.0	Vdc
Drain–Source On–Voltage (V_{GS} = 10 V, I_D = 10 A)	$V_{DS(on)}$	1.0	3.0	5.0	Vdc
Forward Transconductance (V_{DS} = 10 V, I_D = 5.0 A)	g_{fs}	5.0	7.0	—	mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance (V_{DS} = 50 V, V_{GS} = 0, f = 1.0 MHz)	C_{iss}	—	350	—	pF
Output Capacitance (V_{DS} = 50 V, V_{GS} = 0, f = 1.0 MHz)	C_{oss}	—	220	—	pF
Reverse Transfer Capacitance (V_{DS} = 50 V, V_{GS} = 0, f = 1.0 MHz)	C_{rss}	—	15	—	pF
FUNCTIONAL TESTS					
Common Source Amplifier Power Gain, f = 30; 30.001 MHz (V_{DD} = 50 V, P_{out} = 150 W (PEP), I_{DQ} = 250 mA) f = 175 MHz	G_{ps}	18 —	22 13	— —	dB
Drain Efficiency (V_{DD} = 50 V, P_{out} = 150 W (PEP), f = 30; 30.001 MHz, I_D (Max) = 3.75 A)	η	40	45	—	%
Intermodulation Distortion (1) (V_{DD} = 50 V, P_{out} = 150 W (PEP), f = 30 MHz, f2 = 30.001 MHz, I_{DQ} = 250 mA)	$IMD_{(d3)}$ $IMD_{(d11)}$	— —	−32 −60	−30 —	dB
Load Mismatch (V_{DD} = 50 V, P_{out} = 150 W (PEP), f1 = 30; 30.001 MHz, I_{DQ} = 250 mA, VSWR 30:1 at all Phase Angles)	Ψ	No Degradation in Output Power			
CLASS A PERFORMANCE					
Intermodulation Distortion (1) and Power Gain (V_{DD} = 50 V, P_{out} = 50 W (PEP), f1 = 30 MHz, f2 = 30.001 MHz, I_{DQ} = 3.0 A)	G_{PS} $IMD_{(d3)}$ $IMD_{(d9-13)}$	— — —	23 −50 −75	— — —	dB



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.960	0.990	24.39	25.14
B	0.465	0.510	11.82	12.95
C	0.229	0.275	5.82	6.98
D	0.216	0.235	5.49	5.96
E	0.084	0.110	2.14	2.79
H	0.144	0.178	3.66	4.52
J	0.003	0.007	0.08	0.17
K	0.435	---	11.05	---
M	45° NOM		45° NOM	
Q	0.115	0.130	2.93	3.30
R	0.246	0.255	6.25	6.47
U	0.720	0.730	18.29	18.54

STYLE 2:
PIN 1. SOURCE
2. GATE
3. SOURCE
4. DRAIN

CASE 211–11
ISSUE N